

Special Issue

Integrated Fabrication Approaches for Soft Robotics

Message from the Guest Editors

Dear colleagues, Soft robotics is considered the new frontier of Robotics; the substantiation of this expectation requires the convergence of different scientific and technological approaches including additive fabrication, polymer actuation, soft electronics, energy storage and harvesting, neuromorphic stimuli and data handling, and edge computing. This Special Issue aims to gather high-quality research contributions dealing with the integration of different technologies to obtain disruptive structural and functional solutions for soft robotics systems.

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Editor-in-Chief

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